

## 60V N-Channel Power MOSFET

### DESCRIPTION

The MPG30N60 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge. It can be used in a wide variety of applications.

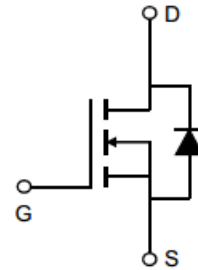
### Application

- Power switching application
- Hard switched and High frequency circuits
- Uninterruptible power supply

### KEY CHARACTERISTICS

- $V_{DS} = 60V, I_D = 30A$   
 $R_{DS(ON)} < 30m\Omega @ V_{GS}=10V$   
 $R_{DS(ON)} < 40m\Omega @ V_{GS}=4.5V$
- High density cell design for lower  $R_{dson}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high EAS
- Excellent package for good heat dissipation

**100% UIS TESTED!**  
**100% DVDS TESTED!**



Schematic diagram

### Package Marking And Ordering Information

Device Marking	Ordering Codes	Package	Product Code	Packing
30N06	MPG30N06-P	TO-220	30N06	Reel

### Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous	$I_D$	30	A
Drain Current-Pulsed (Note 1)	$I_{DM}$	80	A
Maximum Power Dissipation ( $T_c=25^\circ C$ )	$P_D$	44	W
Single pulse avalanche energy (Note 2)	$E_{AS}$	56	mJ
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 175	$^\circ C$

### Thermal Characteristic

Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	3.4	$^\circ C/W$
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Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	60	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	-	-	±100	nA
<b>On Characteristics</b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.3	1.8	2.3	V
Drain-Source On-State Resistance <sup>(Note 3)</sup>	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =10A	-	25	30	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A	-	30	40	
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =5V, I <sub>D</sub> =10A	-	11	-	S
<b>Dynamic Characteristics</b>						
Input Capacitance	C <sub>ISS</sub>	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0MHz	-	670	-	pF
Output Capacitance	C <sub>OSS</sub>		-	76	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	66	-	pF
<b>Switching Characteristics</b> <sup>(Note 4)</sup>						
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =30V, I <sub>D</sub> =10A, V <sub>GS</sub> =10V, R <sub>GEN</sub> =10Ω	-	19.2	-	nS
Turn-on Rise Time	t <sub>r</sub>		-	6.4	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>		-	29.2	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	8.2	-	nS
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =48V, I <sub>D</sub> =10A V <sub>GS</sub> =10V	-	21	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	5	-	nC
Gate-Drain Charge	Q <sub>gd</sub>		-	6.5	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =20A	-	-	1.2	V
Reverse Recovery Time	T <sub>rr</sub>	T <sub>j</sub> =25°C, I <sub>F</sub> =10A, di/dt=100A/uS <sup>(note3)</sup>	-	33.6	-	nS
Reverse Recovery Charge	Q <sub>rr</sub>		-	32.1	-	nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. E<sub>AS</sub> condition : T<sub>j</sub>=25°C, V<sub>DD</sub>=30V, V<sub>GS</sub>=10V, L=0.5mH, R<sub>g</sub>=25Ω
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production.

Characteristics Curves

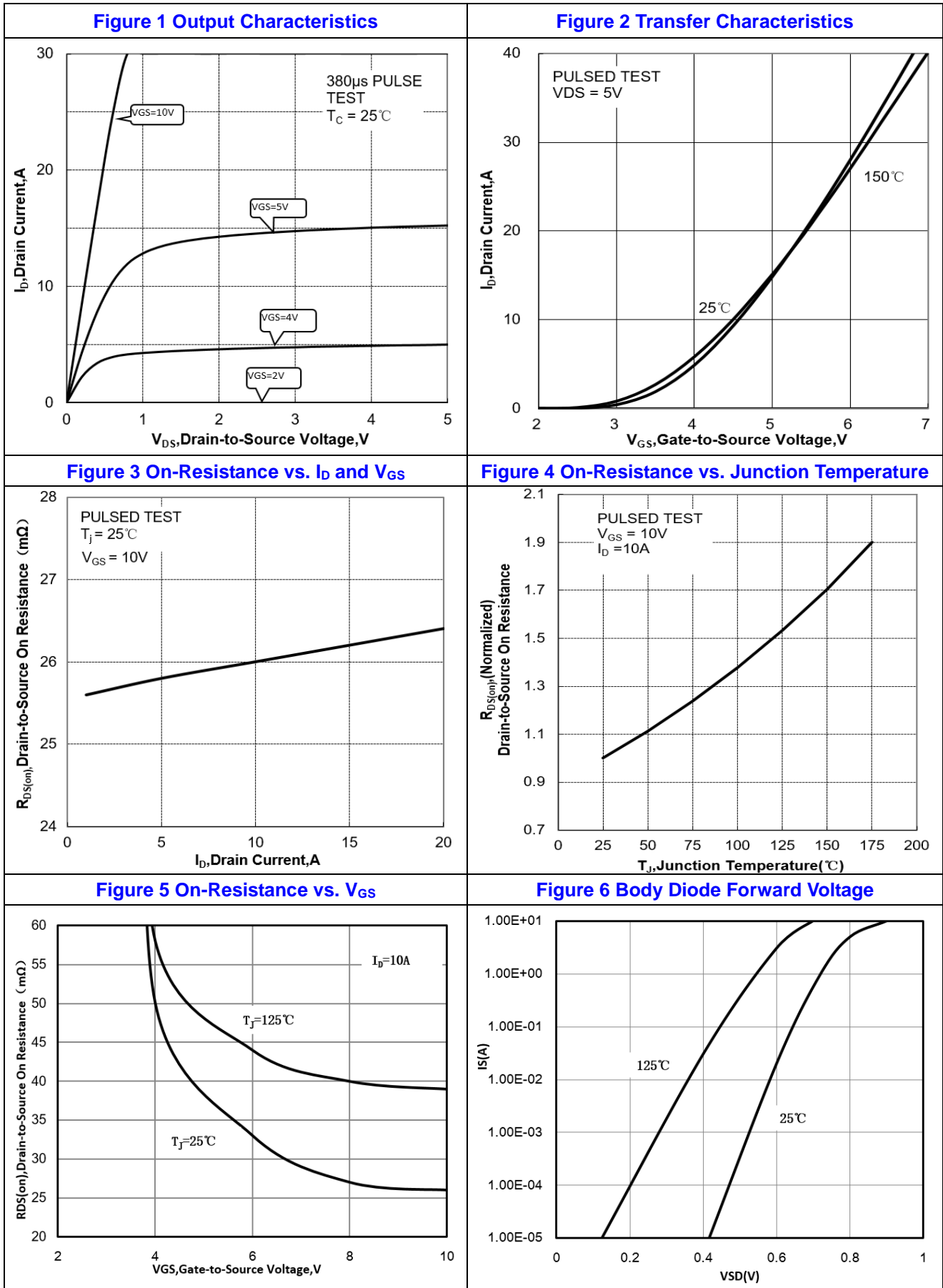


Figure 7 Gate-Charge Characteristics

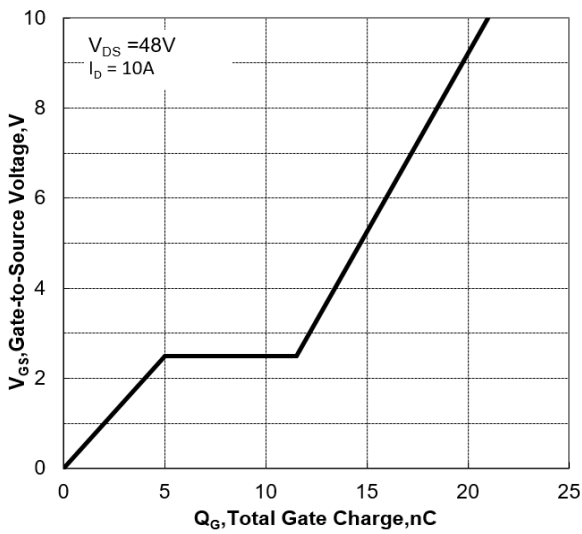


Figure 8 Capacitance Characteristics

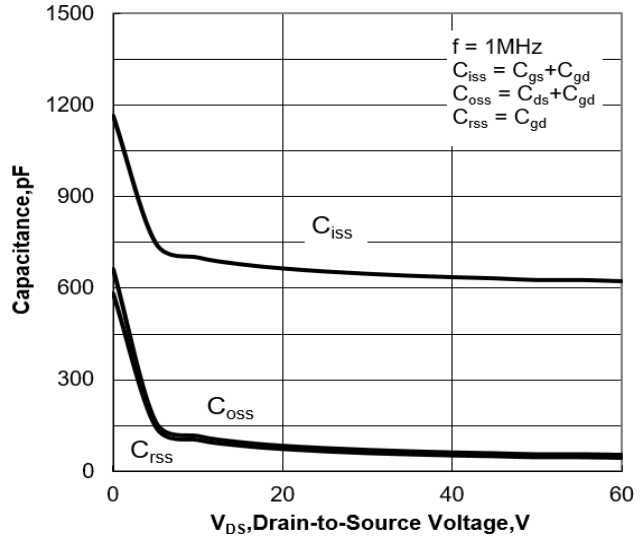


Figure 9 Maximum Forward Biased Safe Operation Area

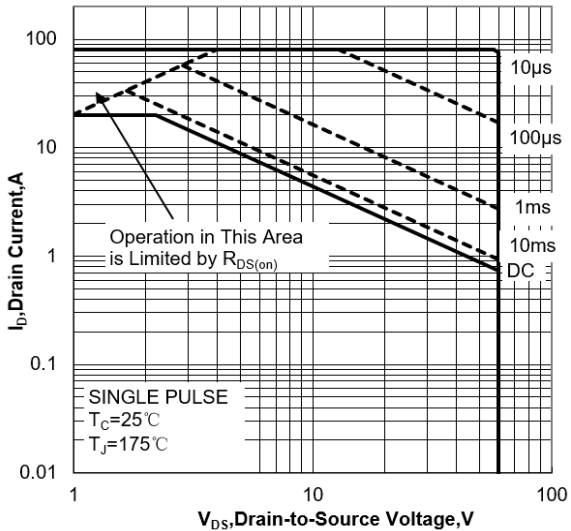


Figure 10 Single Pulse Power Rating Junction-to-Ambient

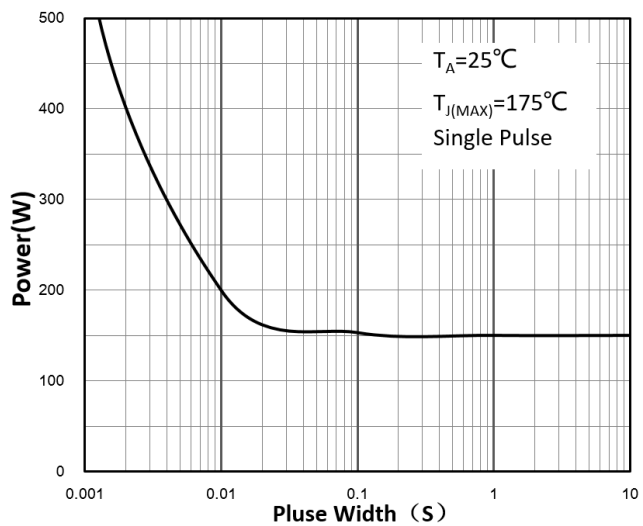
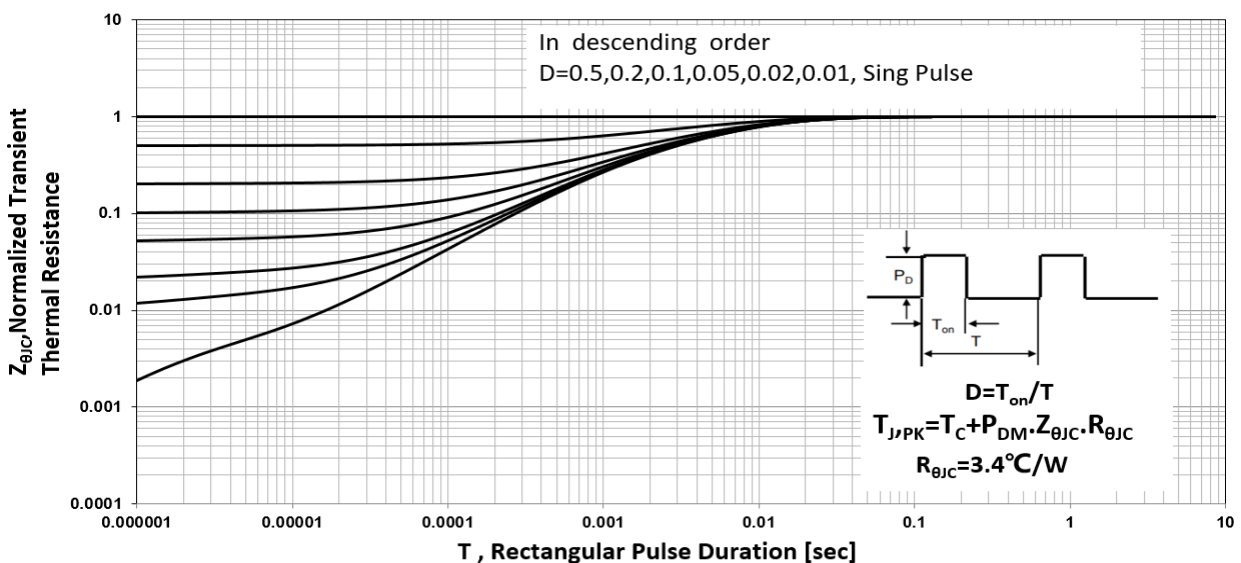


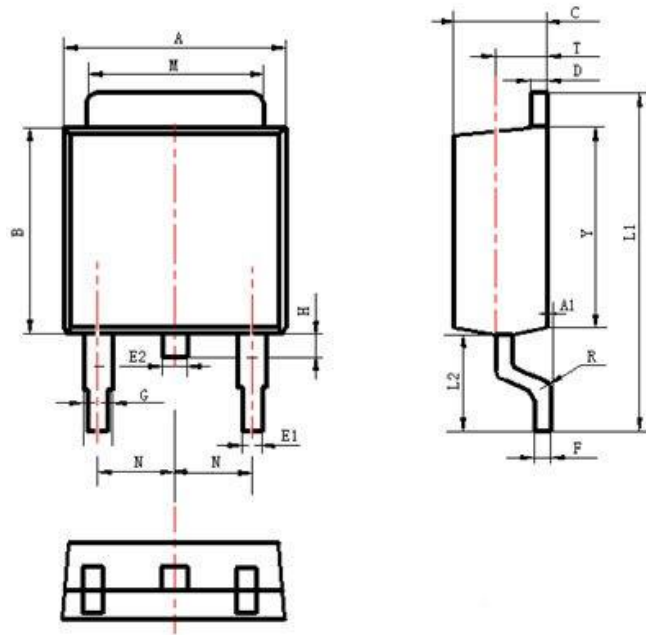
Figure 11 Normalized Maximum Transient Thermal Impedance



**Test Circuit and Waveform**

Gate Charge Test Circuit	Gate Charge Test Waveform
Resistive Switching Test Circuit	Resistive Switching Test Waveforms
Unclamped Inductive Switching (UIS) Test Circuit	Unclamped Inductive Switching (UIS) Test Waveforms
Diode Recovery Test Circuit	Diode Recovery Test Waveforms

Package Description



Items	Values(mm)	
	MIN	MAX
A	6.30	6.90
A1	0	0.13
B	5.70	6.30
C	2.10	2.50
D	0.30	0.60
E1	0.60	0.90
E2	0.70	1.00
F	0.30	0.60
G	0.70	1.20
L1	9.60	10.50
L2	2.70	3.10
H	0.60	1.00
M	5.10	5.50
N	2.09	2.49
R	0.3	
T	1.40	1.60
Y	5.10	6.30

TO-252 Package

**NOTE:**

1. Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. Please do not exceed the absolute maximum ratings of the device when circuit designing.
2. When installing the heat sink, please pay attention to the torsional moment and the smoothness of the heat sink.
3. MOSFETs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it.
4. Shenzhen Minos reserves the right to make changes in this specification sheet and is subject to change without prior notice.

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